





# DATA SHEET GLV92C50501 Series

Part of the simpleLED® Program





#### SimpleLED<sup>®</sup> GLV92C50501 SERIES

The LED module consist s of 35 5630 mid-power LEDs. It is engineered to provide customers with the flexibility to select the optimal light source for their applications. The module series complies with IEC62031 Class III and can be connected with a UL Class 2 driver (alternative configurations should be confirmed.).

#### **PRODUCT DESCRIPTION**

Multiple CCTs available (27000K-5000K) 80& 90 minimum CRI options Targeted 3.5 SDCM color binning LM-80 compliant mid-power LEDs 3-Year Warranty

# TARGET APPLICATIONS

Down Lighting Recessed Lighting Flood Lighting Low Bay High Bay Area Lighting

## APPLIED STANDARDS

IEC 62031, IEC 60068-2, UL8750





## SimpleLED® GLV92C50501-JE35 WHITE SERIES

PARAMETER	CONDITIONS	
DCD	MCPCB with Φ50mm	
РСВ	UL component file number: E250937	
EmitterTime	35 x 5630 mid-power LEDs	
Emiller Type	UL component file number: E347623	
Circuit Layout	5P x 7S	
Connector Type	Wago connector: 2060-401/998-404	
Connector Type	UL component file number: E45171	
Thermal Resistance (p-n junction to Ts)	Rth= 16 °C/W	
Thermal Resistance (Ts to Tp)	Approx. 0.08℃/W	
Thermal Resistance (Ts to the back of Tp)	Approx. 0.11℃/W	

Note: Tj = Tp + ( Rj-s + Rs-p ) x Power of single LED

# PRODUCT SELECTION GUIDE

PART NUMBER (WITHOUT CONFORMAL COATING)	PART NUMBER (WITH CONFORMAL COATING)	сст	CRI (min.)
GLV92C50501/CW-JE35I27A	GLV9FC50501/CW-JE35I27A	2700K	80
GLV92C50501/CW-JE35I30A	GLV9FC50501/CW-JE35I30A	3000K	80
GLV92C50501/CW-JE35K30A	GLV9FC50501/CW-JE35K30A	30004	90
GLV92C50501/CW-JE35I35A	GLV9FC50501/CW-JE35I35A	3500K	80
GLV92C50501/CW-JE35I40A GLV9FC50501/CW-JE35I40A		40001/	80
GLV92C50501/CW-JE35K40A	GLV9FC50501/CW-JE35K40A	4000K	90
GLV92C50501/CW-JE35I50A	GLV9FC50501/CW-JE35I50A	5000K	80





## BOARD OPTICAL CHARACTERISTICS (@ 350mA, Ts=25 °C)

BOARD CCT	CRI	FLUX (lm)		EFFICACY (Im/W)		
		MIN.	TYP.	MIN.	TYP.	
	2700K	80	1058	1096	144	154
3000K GLV92C50501/C W-JE35 4000K	80	1077	1115	147	157	
	90	851	926	116	130	
	80	1096	1134	149	160	
	80	1134	1171	154	165	
	90	945	1021	129	144	
	5000K	80	1172	1210	159	170

## BOARD OPTICAL CHARACTERISTICS (@ 500mA, Ts=25 °C)

BOARD CCT		FLUX (Im)		EFFICACY (Im/W)		
		CRI	MIN.	TYP.	MIN.	TYP.
	2700K	80	1421	1472	135	145
	80	1446	1497	138	148	
	3000K	90	1142	1243	109	123
GLV92C50501/C W-JE35	3500K	80	1472	1523	140	150
	40001/	80	1523	1573	145	155
4000K	90	1269	1370	121	135	
	5000K	80	1573	1624	150	160

#### **BOARD ELECTRICAL CHARACTERISTICS\***

	Min.	Тур.	Max.
Voltage (V)**	19.6	20.3	21.0
Total Board Power (W) @350mA	6.86	7.11	7.35
Total Board Power (W) @500mA	9.80	10.15	10.50





#### **ENVIRONMENTAL CHARACTERISTICS**

	Min.	Max.
Storage Temperature	-40°C	100ºC
	Min.	Max.
PCB Temperature (T <sub>p</sub> )	-40°C	80ºC

#### NOTES

\* Based on nominal LED datasheet values (65 mA,  $T_s = 25^{\circ}$ C). Use for reference only since application temperature and LED driver current have an influence on lumen output and forward voltage. Safe operation only possible by the use of an external constant-current source. The current source used for operation, must have the following protections:

- Short-circuit protection
- Overload protection
- Over-temperature protection

\*\*LED SUPPLIER maintains a tolerance of  $\pm 0.1 \text{V}$  on forward voltage measurements.

Proper current de-rating must be observed to maintain junction temperature below the maximum.

Different CCTs available upon request. Contact your local sales representative.

#### INTERCONNECTIVITY OPTIONS

#### Board-to-Board wiring options and drawings.



GLV92C84841/CW-JI90		
Maximum connection units	8PCS in series	







#### **TYPICAL CHARACTERISTICS GRAPHS**



Relative Luminous Flux vs. Temperature Relative Luminous Flux(%) Ts(℃)





## **TYPICAL CHARACTERISTICS GRAPHS**









#### LIFETIME/LUMEN MAINTENANCE INFORMATION

Current(mA)	350	500
L70(hrs)	>50,000	>50,000
Ts(℃)	84	84

#### PART NUMBERING & ORDERING INFORMATION

1. PRODUCT SERIES

GLV92C50501

Circular MCPCB with 35LEDs

without conformal coating

GLV9FC50501

- Circular MCPCB with 35LEDs

with conformal coating

#### 2. CONNECTOR TYPE

CW - Wago connector 2060-401/998-404

3. LED TYPE

JE- 5630 mid-power LED 5P

4. NUMBER OF LED

35 – 35 LEDs

#### 5. CCT

I27 - CRI80 2700K ANSI
I30 - CRI80 3000K ANSI
K30 - CRI90 3000K ANSI
I35 - CRI80 3500K ANSI
I40 - CRI80 4000K ANSI
K40 - CRI80 4000K ANSI
I50 - CRI80 5000K ANSI

6. FLUX BIN A – S0 Bin

\*Comment:

- 1. For CRI80 version, flux bin is S3.
- For CRI90 version, flux bin is S1. (S1/SZ is acceptable for 4000K version)

Part Number :





#### MECHANICAL DIMENSIONS

All dimensions are in millimeters







## THERMAL CONSIDERATIONS

The LED module must be operated in environmental conditions where the ambient air temperature does NOT exceed a value which would cause the LEDs to exceed their maximum junction temperature (per the LED Supplier datasheet ) or cause the maximum board temperature (Tp) to be exceeded.

A heat sink can be used with the LED modules in order to maintain the LED junction temperature and the PCB temperature below their maximum ratings however, the following recommendations should be followed: •The mounting surface for the LED module must be flat;

•Avoid bending of the PCB to avoid damaging the LEDs and the solder connections;

•Use a thermal interface material between the PCB and the heat sink.

For optimal lifetime performance, the LED module must be placed in an environment where air can flow freely around the luminaire, promoting heat transfer from conduction to the heat sink and from radiation to the air. It is not recommended to expose the module to direct sunlight or any other heat source.

#### **Thermal Measurement**



In order to obtain an LED lifetime B50L70 of 50,000 hours , the maximum allowed solder pad temperature  $T_s$  is 84°C at a board current of 350mA,500mA.

The maximum allowed temperature at the  $T_P$  point of the board is 80°C. This temperature is not based on the LM-80 standard but is for warranty purposes only.





#### CIRCULAR LIGHT ENGINE

#### Assembly and Safety Information

Installation must be done according to relevant regulations and standards. The following guidelines should be respected:

•Installation must be carried out in a voltage-free state;

•The LED module contains components that are sensitive to electrostatic discharge and may only be installed in the factory and on site if appropriate EOS/ESD protection measures have been taken;

•A thermal interface material should be applied to the base of the PCB before fixing it onto a heat sink with screws. The fixing/cooling surface must be cleaned prior to installing the PCB to remove all dirt, dust and grease. The LED module must not be bent to avoid damaging the LEDs.

•Use wire size AWG 24-18 to connect the PCB to the constant-current power supply.

•Conductors must be inserted at a 0° angle to the PCB.

•Wires must be stripped to 6-7 mm (solid & stranded).





- 1. Insert solid conductors via push-in termination.
- 2. Insert/remove fine-stranded conductors by lightly pressing on the push-button

•The pressure on the LEDs will influence their reliability. Precautions should be taken to avoid such pressure. •Do not stack PCBs on each other. LED materials are soft and this could lead to catastrophic failure of the LEDs.

•Chemicals can be harmful to the LEDs used on the module. It is recommended not to use chemicals anywhere in an LED system. The fumes from even small amounts of chemicals may damage the LEDs.

•Using corrugated boxes as packaging is only allowed if the sulfur used in the box is less than 850 ppm. •Please ensure the correct polarity of the leads.

•For outdoor or damp locations, care must be taken to protect the LED PCB against moisture. There is the possibility of coating the board. Please contact your local sales representative for more information.

All of the above guidelines must be followed in order to qualify for the 3-year warranty. There is the possibility to extend to a 5-year warranty, please contact your local sales representative.





#### PACKAGING INFORMATION



